



SamHop Microelectronics Corp.



STB/P434S

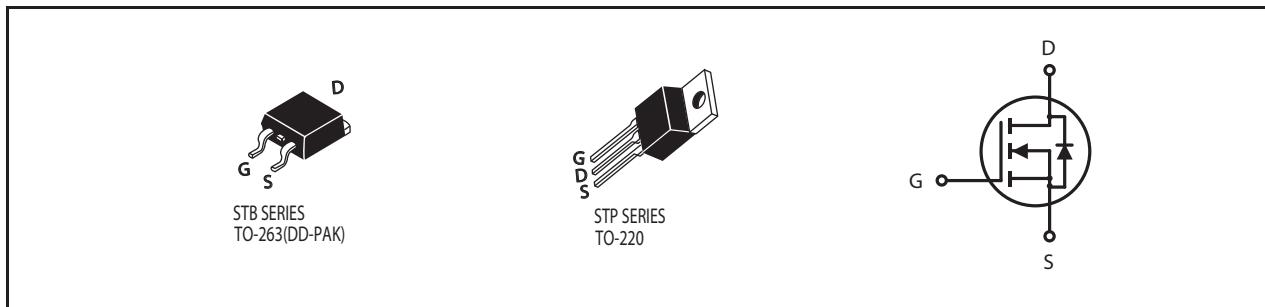
Ver 1.0

N-Channel Logic Level Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
VDSS	ID	RDS(ON) (mΩ) Max
40V	60A	9.2 @ VGS=10V
		11.5 @ VGS=4.5V

FEATURES

- Super high dense cell design for low RDS(ON).
- Rugged and reliable.
- TO-220 and TO-263 Package.



ABSOLUTE MAXIMUM RATINGS ($T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Limit	Units
V_{DS}	Drain-Source Voltage	40	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Drain Current-Continuous ^a	$T_C=25^\circ\text{C}$	A
		$T_C=70^\circ\text{C}$	A
I_{DM}	-Pulsed ^b	176	A
E_{AS}	Single Pulse Avalanche Energy ^d	91	mJ
P_D	Maximum Power Dissipation ^a	$T_C=25^\circ\text{C}$	W
		$T_C=70^\circ\text{C}$	W
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 to 150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

$R_{\theta JC}$	Thermal Resistance, Junction-to-Case ^a	2	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient ^a	62.5	$^\circ\text{C/W}$

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ELECTRICAL CHARACTERISTICS (TA=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BVdss	Drain-Source Breakdown Voltage	VGS=0V , ID=250uA	40			V
Idss	Zero Gate Voltage Drain Current	VDS=32V , VGS=0V			1	uA
IGSS	Gate-Body Leakage Current	VGS= ±20V , VDS=0V			±100	nA
ON CHARACTERISTICS						
VGS(th)	Gate Threshold Voltage	VDS=VGS , ID=250uA	1.3	1.7	3	V
RDS(ON)	Drain-Source On-State Resistance	VGS=10V , ID=30A		7.6	9.2	m ohm
		VGS=4.5V , ID=25A		8.8	11.5	m ohm
gFS	Forward Transconductance	VDS=10V , ID=30A		18		S
DYNAMIC CHARACTERISTICS ^c						
Ciss	Input Capacitance	VDS=20V,VGS=0V f=1.0MHz		1160		pF
Coss	Output Capacitance			211		pF
CRSS	Reverse Transfer Capacitance			135		pF
SWITCHING CHARACTERISTICS ^c						
tD(ON)	Turn-On Delay Time	VDD=20V ID=1A VGS=10V RGEN=3.3 ohm		17		ns
tr	Rise Time			24		ns
tD(OFF)	Turn-Off Delay Time			59		ns
tf	Fall Time			11		ns
Qg	Total Gate Charge	VDS=20V, ID=30A, VGS=10V		20		nC
		VDS=20V, ID=30A, VGS=4.5V		10		nC
Qgs	Gate-Source Charge	VDS=20V, ID=30A, VGS=10V		2.1		nC
Qgd	Gate-Drain Charge			5		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
Is	Maximum Continuous Drain-Source Diode Forward Current			10		A
VSD	Diode Forward Voltage ^b	VGS=0V, Is=10A		0.84	1.3	V
Notes						
a.Surface Mounted on FR4 Board,t ≤ 10sec.						
b.Pulse Test:Pulse Width ≤ 300us, Duty Cycle ≤ 2%.						
c.Guaranteed by design, not subject to production testing.						
d.Starting TJ=25°C,L=0.5mH,VDD = 20V.(See Figure13)						

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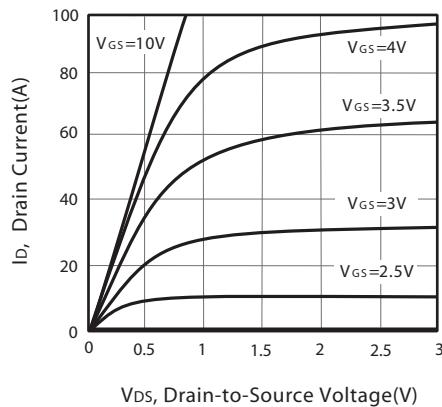


Figure 1. Output Characteristics

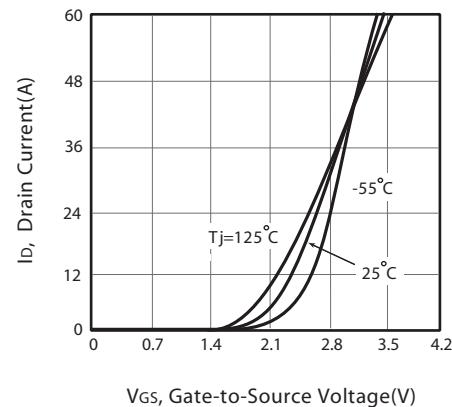


Figure 2. Transfer Characteristics

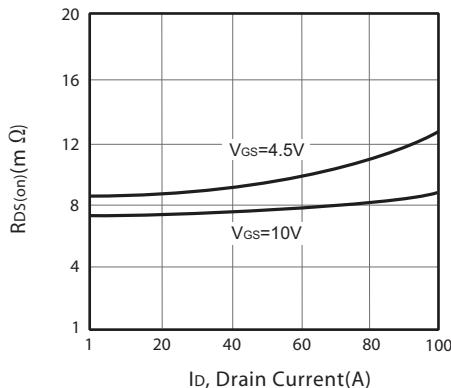


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

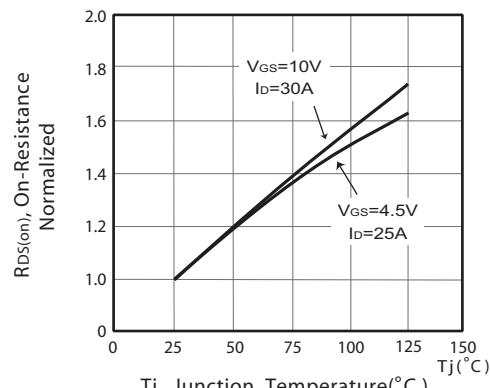


Figure 4. On-Resistance Variation with Drain Current and Temperature

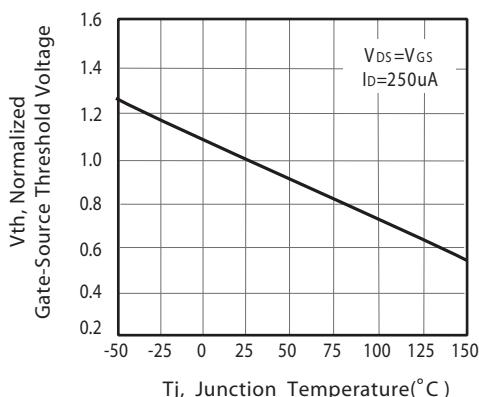


Figure 5. Gate Threshold Variation with Temperature

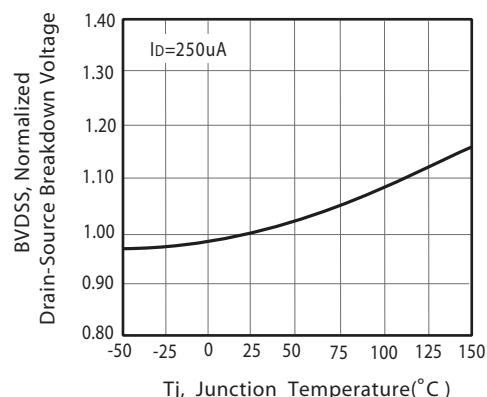
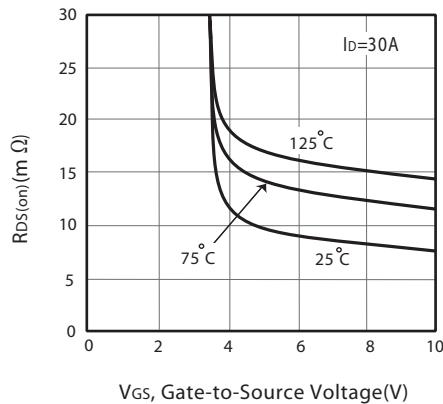


Figure 6. Breakdown Voltage Variation with Temperature

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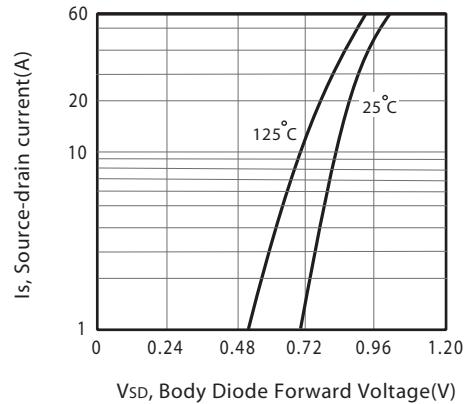
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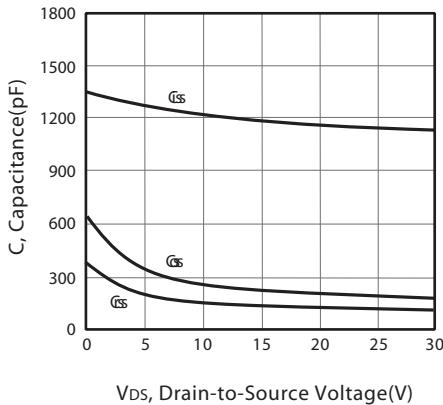
V_{GS}, Gate-to-Source Voltage(V)

Figure 7. On-Resistance vs. Gate-Source Voltage



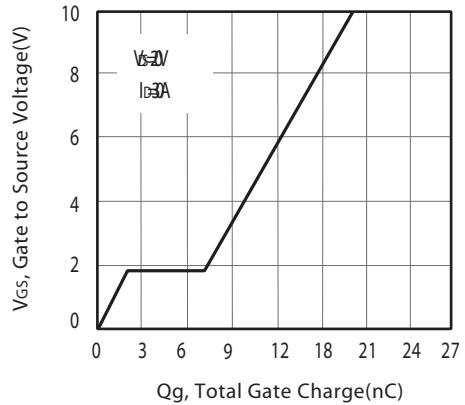
V_{SD}, Body Diode Forward Voltage(V)

Figure 8. Body Diode Forward Voltage Variation with Source Current



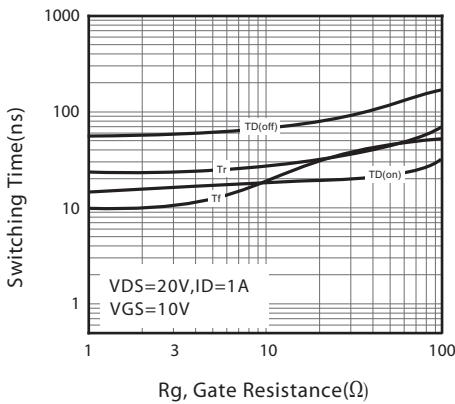
V_{DS}, Drain-to-Source Voltage(V)

Figure 9. Capacitance



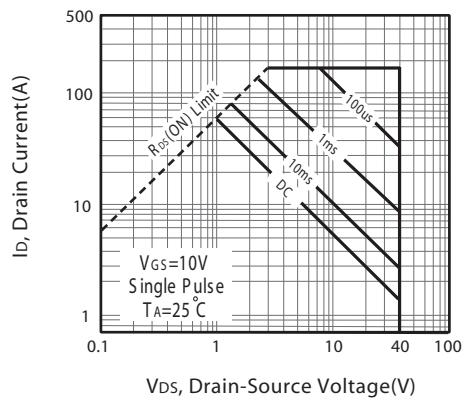
Q_g, Total Gate Charge(nC)

Figure 10. Gate Charge



R_g, Gate Resistance(Ω)

Figure 11. switching characteristics



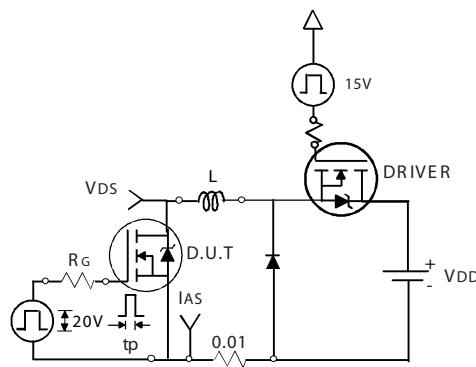
V_{DS}, Drain-Source Voltage(V)

Figure 12. Maximum Safe Operating Area

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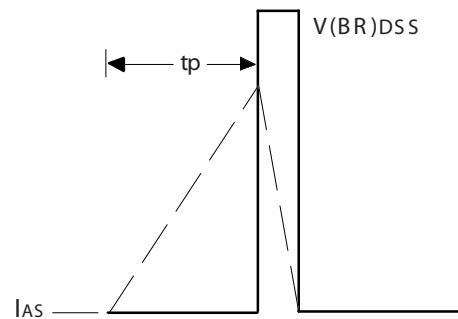
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Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.

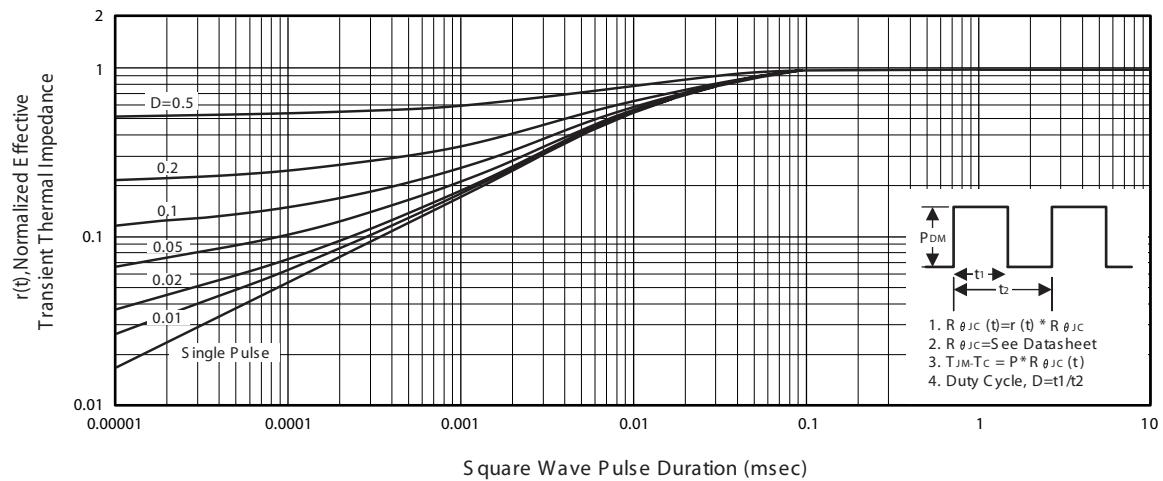
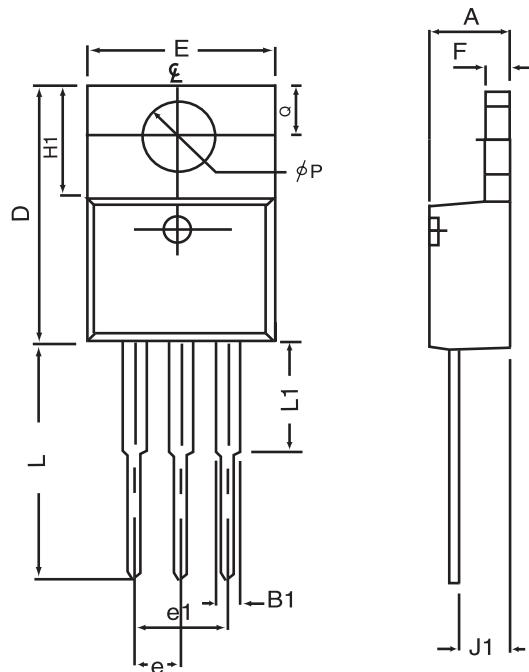


Figure 14. Normalized Thermal Transient Impedance Curve

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PACKAGE OUTLINE DIMENSIONS

TO-220



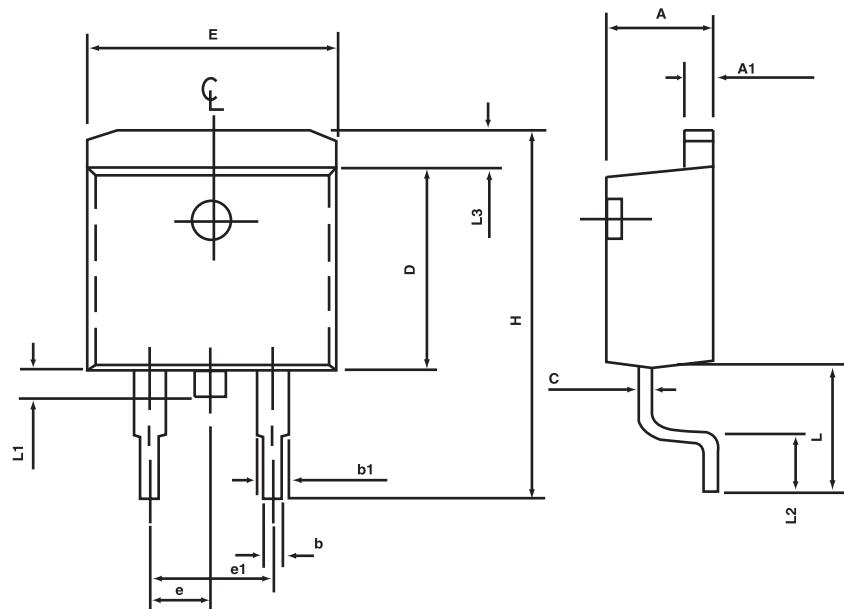
SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.32	4.80	0.170	0.189
B1	1.27	1.65	0.050	0.630
D	14.6	16.00	0.575	0.610
E	9.70	10.41	0.382	0.410
e	2.34	2.74	0.092	0.108
e1	4.68	5.48	0.184	0.216
F	1.14	1.40	0.045	0.055
H1	5.97	6.73	0.235	0.265
J1	2.20	2.79	0.087	0.110
L	12.88	14.22	0.507	0.560
L1	3.00	6.35	0.120	0.250
φP	3.50	3.94	0.138	0.155
Q	2.54	3.05	0.100	0.120

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PACKAGE OUTLINE DIMENSIONS

TO-263AB



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.30	4.70	0.169	0.185
A1	1.22	1.32	0.048	0.055
b	0.69	0.94	0.027	0.037
b1	1.22	1.40	0.048	0.055
C	0.36	0.56	0.014	0.022
D	8.64	9.652	0.340	0.380
E	9.70	10.54	0.382	0.415
e	2.29	2.79	0.090	0.110
e1	4.83	5.33	0.190	0.210
H	14.60	15.78	0.575	0.625
L	4.70	5.84	0.185	0.230
L1	1.20	1.778	0.047	0.070
L2	2.24	2.84	0.088	0.111
L3	1.40 MAX		0.055 MAX	

TO-220/263AB Tube

